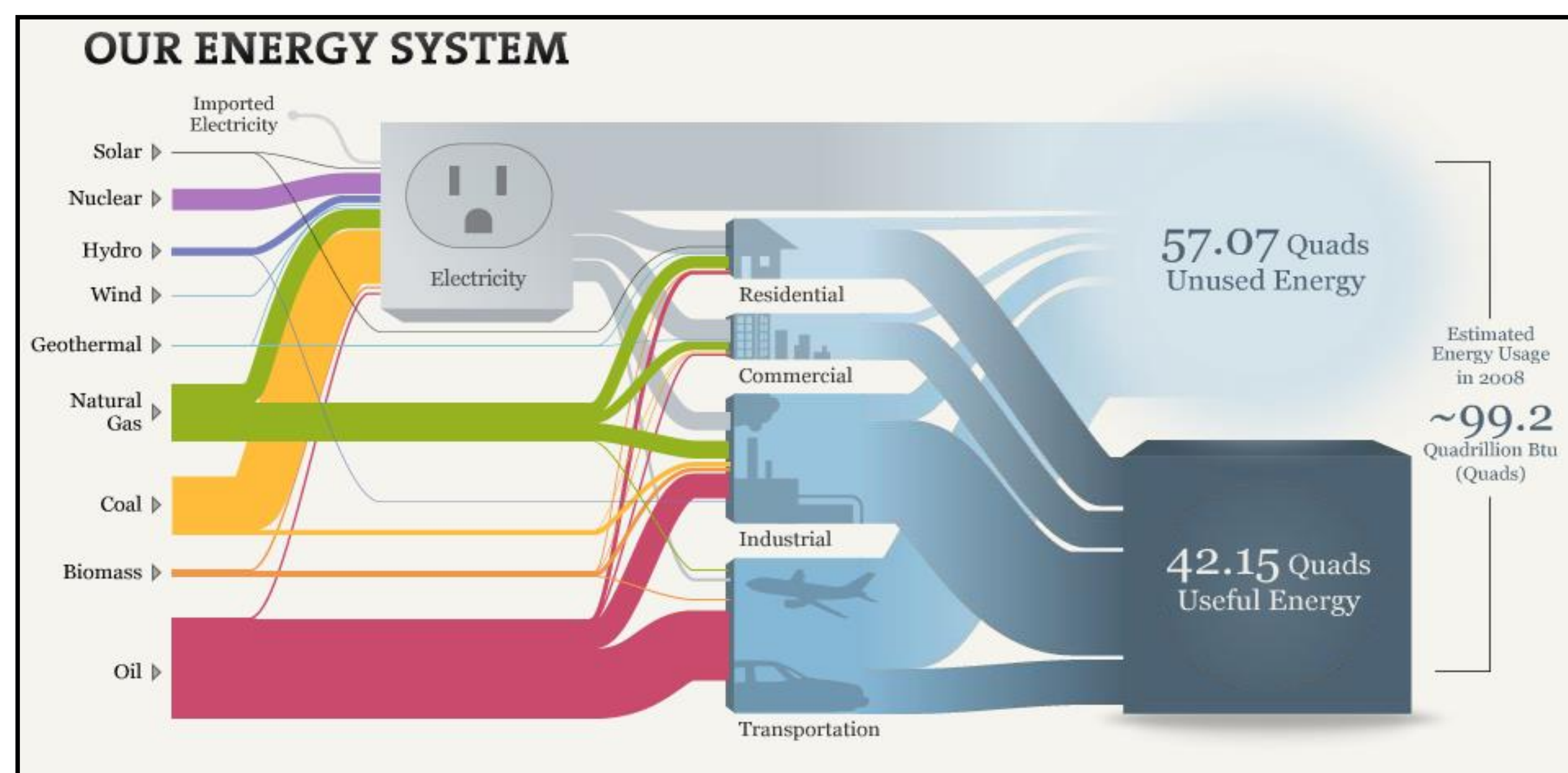


# CHARACTERIZATION OF RARE EARTH-DOPED III-V THERMOELECTRIC MATERIALS

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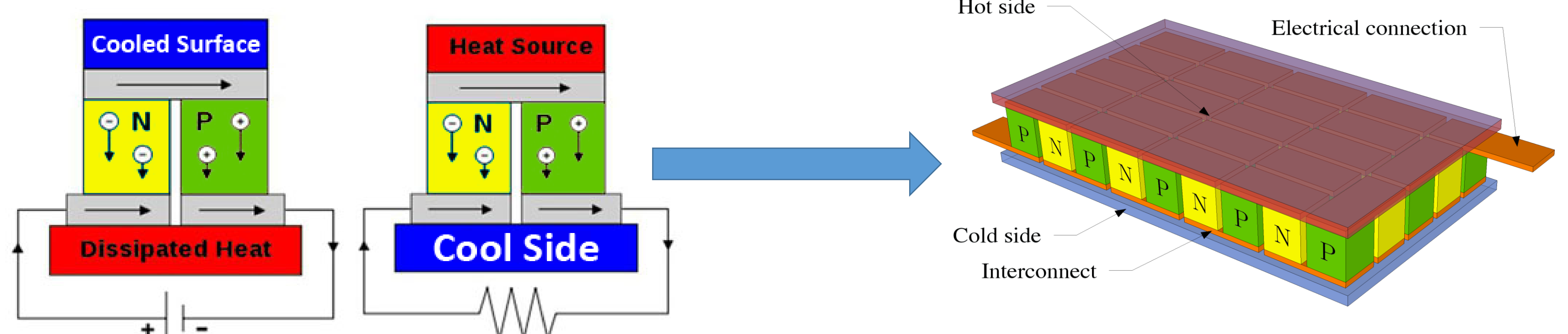
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## Energy Efficiency: We Lose More Than We Use



## Thermoelectric Devices

- Convert waste heat into usable electricity
- Hot charge carriers move to the cold side, producing a current
- Solid-state, robust, and require little maintenance



## Semiconductors and the Thermoelectric Effect

### The Thermoelectric Figure of Merit (ZT)

$$ZT = \frac{S^2 \sigma}{\kappa} T$$

Thermal conductivity (LOW)

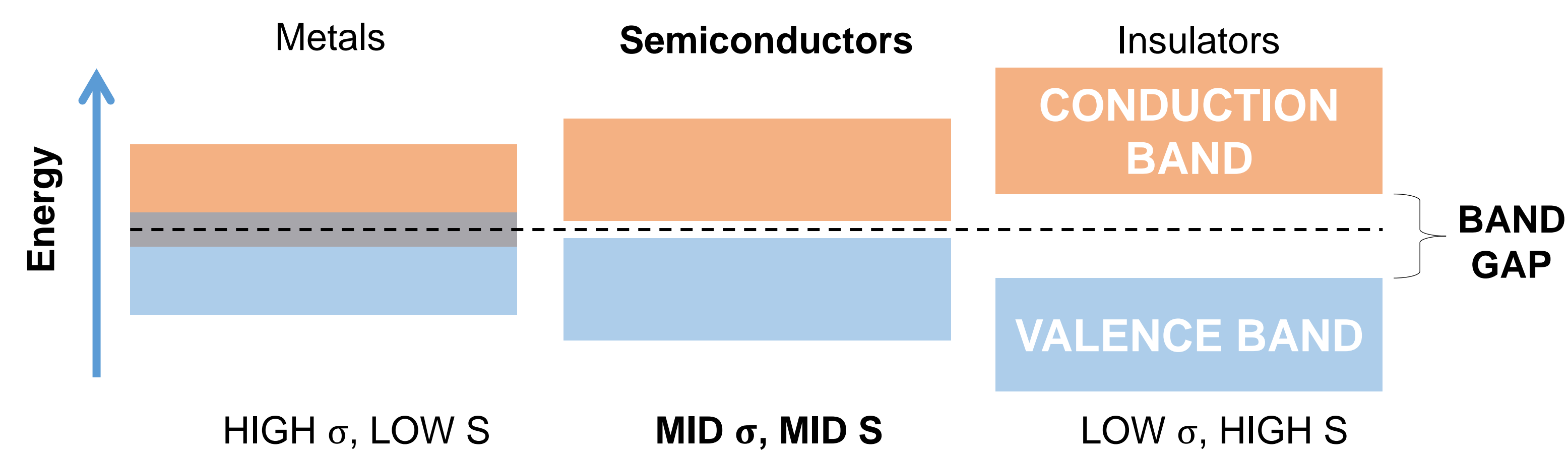
Seebeck coefficient (HIGH)

Electrical conductivity (HIGH)

### "Power Factor"

$$S^2 \sigma$$

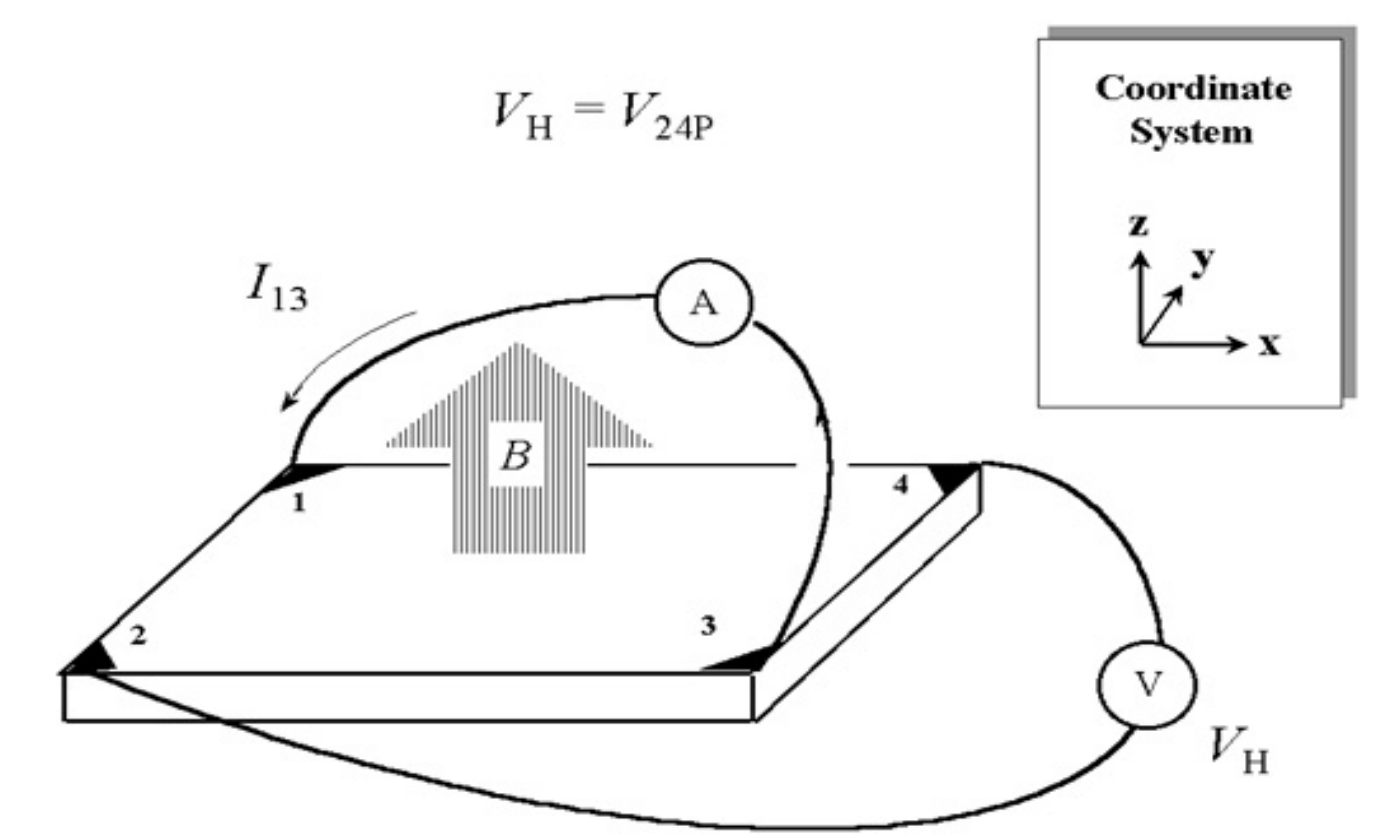
MAXIMIZE



### Hall Measurement

- Material conductivity ( $\sigma$ )
- Carrier concentration ( $n$ )
- Carrier mobility ( $\mu$ )

$$\sigma = nq\mu$$

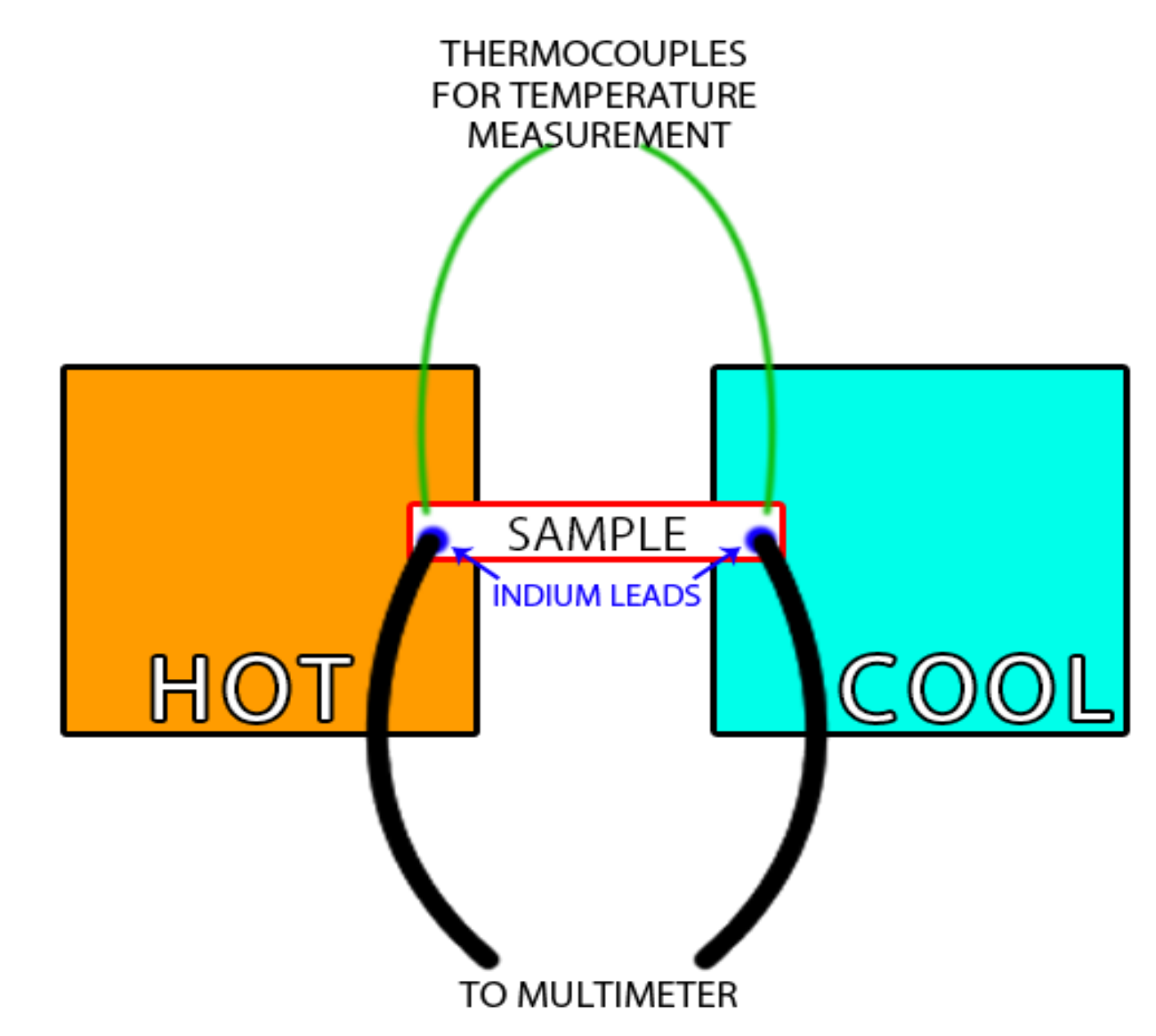


Van der Pauw Technique  
Source: <http://tau.nanophys.kth.se/cmp/hall/node5.html>

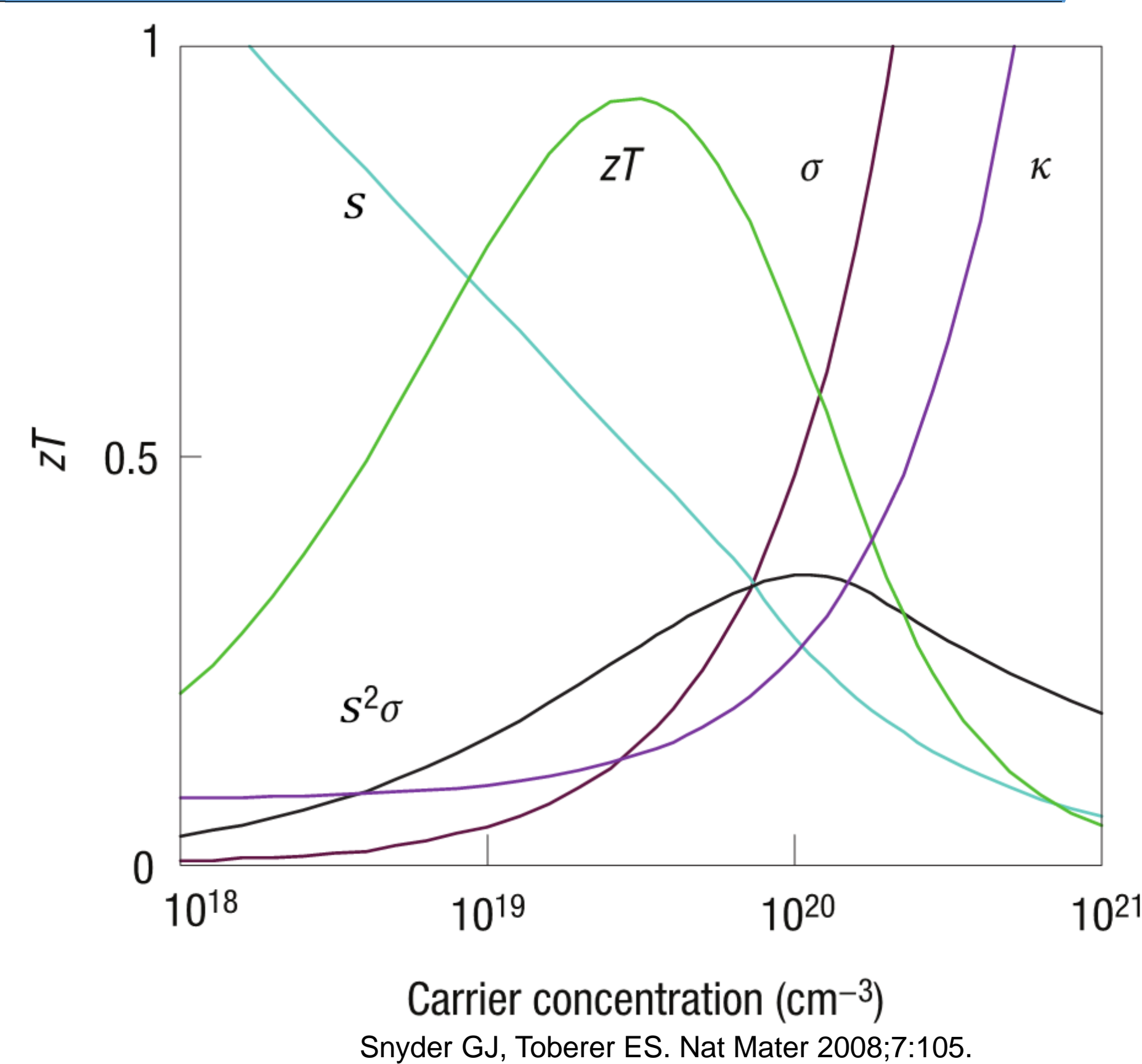
### Seebeck Measurement

- Change in voltage induced by a temperature difference
- Positive for p-type material
- Negative for n-type material

$$S = \frac{\Delta V}{\Delta T}$$



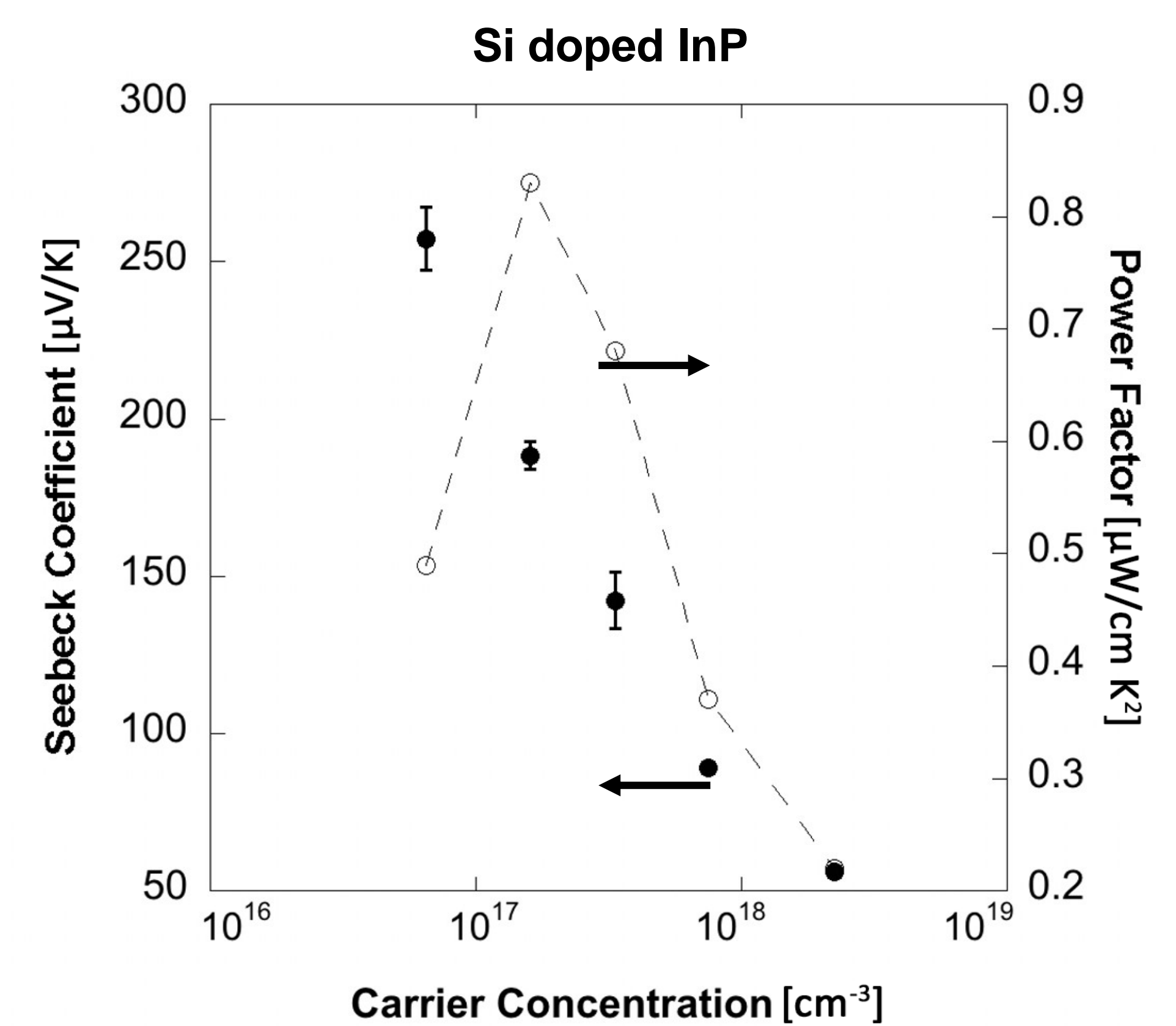
## Balancing the Components of ZT



Inverse relationship between  $S$  and  $n$  indicates a balance is needed to maximize the power factor.

This optimal power factor can be achieved by varying the dopant concentration in the material.

Experimental results of Si doped InP will serve as a baseline for comparison with rare earth doped material.



## Future Work and Expectations

The next steps are to grow series of Er:InP, Si:InAsP and Er:InAsP at different Si and Er concentrations. This will allow us to make direct comparisons between the binary compound, InP, and the ternary compound, InAsP, as well as any differences in the incorporation and ionization behavior of Er compared to Si in these materials. The ternary alloy InAsP is expected to have significantly lower thermal conductivity due to alloy scattering, however, the added lattice complexity may reduce the maximum doping concentration that it is possible to achieve.

## Acknowledgements

CNSI Center for Science and Engineering Partnerships (CSEP) for funding the project through the Early Undergraduate Research and Knowledge Acquisition (EUREKA) program and lab mentor Ryan Need for his support and guidance.